SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORP Form 20-F April 27, 2012

UNITED STATES SECURITIES AND EXCHANGE COMMISSION WASHINGTON, D.C. 20549

FORM 20-F

ANNUAL REPORT PURSUANT TO SECTION 13 OR 15(d) OF THE SECURITIES EXCHANGE ACT OF 1934
For the fiscal year ended December 31, 2011
Commission file number 1-31994

Semiconductor Manufacturing International Corporation

(Exact name of Registrant as specified in its charter)

Not Applicable

(Translation of Registrant s name into English)

Cayman Islands

(Jurisdiction of incorporation or organization)

18 Zhangjiang Road, Pudong New Area, Shanghai, China 201203

(Address of principal executive offices)

Mr. Gary Tseng, Chief Financial Officer

Telephone: (8621) 3861-0000

Telephone: (8621) 3861-0000 Facsimile: (8621) 3895-3568

(Name, Telephone, E-mail and/or Facsimile Number and Address of Company Contact Person)

Securities registered or to be registered pursuant to Section 12(b) of the Act.

Title of each class Name of each exchange on which registered

Ordinary Shares, par value US\$0.0004

American Depositary Shares

The Stock Exchange of Hong Kong Limited*
The New York Stock Exchange, Inc.

Securities registered or to be registered pursuant to Section 12(g) of the Act.

None (Title of Class) Securities for which there is a reporting obligation pursuant to Section 15(d) of the Act. None (Title of Class)

Indicate the number of outstanding shares of each of the issuer s classes of capital or ordinary shares as of the close of the period covered by the annual report.

As of December 31, 2011, there were 27,487,676,065 ordinary shares, par value US\$0.0004 per share, outstanding, of which 1,940,075,200 ordinary shares were held in the form of 38,801,504 ADSs. Each ADS represents 50 ordinary shares.

Indicate by check mark if the registrant is a well-known seasoned issuer, as defined in Rule 405 of the Securities Act. Yes b No o

If this report is an annual or transition report, indicate by check mark if the registrant is not required to file reports pursuant to Section 13 or 15 (d) of the Securities Exchange Act of 1934. Yes o No b

Indicate by check mark whether the registrant: (1) has filed all reports required to be filed by Section 13 or 15(d) of the Securities Exchange Act of 1934 during the preceding 12 months (or for such shorter period that the registrant was required to file such reports), and (2) has been subject to such filing requirements for the past 90 days. Yes b No o

Indicate by check mark whether the registrant has submitted electronically and posted on its corporate Web site, if any, every Interactive Data File required to be submitted and posted pursuant to Rule 405 of Regulation S-T (§232.405 of this chapter) during the preceding 12 months (or for such shorter period that the registrant was required to submit and post such files). Yes b No o

Indicate by check mark whether the registrant is a large accelerated filer, an accelerated filer, or a non-accelerated filer. See definition of accelerated filer and large accelerated filer in Rule 12b-2 of the Securities Exchange Act of 1934 (Check one):

Large accelerated filer b Non-accelerated filer o Accelerated filer o Smaller reporting company o

(Do not check if a smaller reporting company)

Indicate by check mark which basis of accounting the registrant has used to prepare the financial statements included in this filing:

International Financial Reporting Standards as issued U.S. GAAP b Other o by the International Accounting Standards Board o

If this is an annual report, indicate by check mark whether the registrant is a shell company (as defined in Rule 12b-2 of the Securities Exchange Act of 1934). Yes o No b

* Not for trading, but only in connection with the listing of American Depositary Shares on the New York Stock Exchange, Inc.

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FORWARD-LOOKING STATEMENTS

This annual report contains, in addition to historical information, forward-looking statements within the meaning of the safe harbor provisions of the U.S. Private Securities Litigation Reform Act of 1995. These forward-looking statements are based on our current assumptions, expectations and projections about future events. We use words like believe, anticipate, intend, estimat expect, project and similar expressions to identify looking - statements, although not all forward-looking statements contain these words. These forward-looking statements are necessarily estimates reflecting the best judgment of our senior management and involve significant risks, both known and unknown, uncertainties and other factors that may cause our actual performance, financial condition or results of operations to be materially different from those suggested by the forward-looking statements including, among others:

- risks associated with cyclicality and market conditions in the semiconductor industry;
- intense competition;
- timely wafer acceptance by our customers;
- timely introduction of new technologies;
- our ability to ramp new products into volume, supply and demand for semiconductor foundry services;
- our anticipated capital expenditures for 2012;
- our anticipated investments in research and development, anticipated changes to our liability for unrecognized tax benefits:
- industry overcapacity;
- shortages in equipment, components and raw materials;
- · availability of manufacturing capacity; and
- financial stability in end markets.

Except as required by law, we undertake no obligation and do not intend to update any forward-looking statement, whether as a result of new information, future events or otherwise.

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ADDITIONAL INFORMATION

References in this annual report to:

- ADSs are to American Depositary Shares;
- Average selling price of wafers or ASP are to simplified average selling price which is calculated tast revenue divided by total shipments;
- China or the PRC are to the People's Republic of China, excluding for the purpose of this are post, Hong Kong, Macau and Taiwan:
- Company, SMIC, we, our and us are to Semiconductor Manufacturing Orderocations, la Cayman Islands company;

Directors are to the members of our board of directors;

- EUR are to Euros;
- Global Offering are to the initial public offering of our ADSs and our ordinary shares, which offering as completed on March 18, 2004;

Group are to SMIC and all of its subsidiaries.

- HK\$ are to Hong Kong dollars;
- NYSE or New York Stock Exchange are to the New York Stock Exchange, Inc.;
- Rmb or RMB are to Renminbi;
- SEC are to the U.S. Securities and Exchange Commission;
- SEHK, HKSE or Hong Kong Stock Exchange are to The Stock Exchange of Hong Kong Limited;
- U.S. GAAP are to generally accepted accounting principles in the United States; and
- US\$ or USD are to U.S. dollars.

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All references in this annual report to silicon wafer quantities are to 8-inch wafer equivalents, unless otherwise specified. Conversion of quantities of 12-inch wafers to 8-inch wafer equivalents is achieved by multiplying the number of 12-inch wafers by 2.25. When we refer to the capacity of wafer fabrication facilities, we are referring to the installed capacity based on specifications established by the manufacturers of the equipment used in those facilities. References to key process technology nodes, such as 0.35 micron, 0.25 micron, 0.18 micron, 0.15 micron, 0.13 micron, 90 nanometer, 65 nanometer and 45 nanometer include the stated resolution of the process technology, as well as intermediate resolutions down to but not including the next key process technology node of finer resolution. For example, when we state 0.25 micron process technology, that also includes 0.22 micron, 0.21 micron, 0.20 micron and 0.19 micron technologies and 0.18 micron process technology also includes 0.17 micron and 0.16 micron technologies.

Unless otherwise indicated, our financial information presented in this annual report has been prepared in accordance with U.S. GAAP.

All references to our ordinary shares in this annual report gives effect to the 10-for-1 share split we effected in the form of a share dividend immediately prior to the completion of the Global Offering. All references to price per ordinary share and price per preference share reflect the share split referenced above.

The Glossary of Technical Terms contained in Annex A of this annual report sets forth the description of certain technical terms and definitions used in this annual report.

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PARTI

Item 1. Identity of Directors, Senior Management and Advisors

Not applicable.

Item 2. Offer Statistics and Expected Timetable

Not applicable.

Item 3. Key Information

A. Selected Consolidated Financial Data

The selected consolidated financial data presented below as of and for the years ended December 31, 2009, 2010 and 2011 are derived from, and should be read in conjunction with our audited consolidated financial statements, including the related notes, included elsewhere in this annual report. The selected consolidated financial data presented below as of and for the years ended December 31, 2007 and 2008 are derived from our audited consolidated financial statements not included in this annual report.

On March 1, 2011, we sold our majority ownership interest in Semiconductor Manufacturing International (AT) Corporation (AT) and deconsolidated the entity. We reported the results of AT as a discontinued operation in the condensed consolidated statements of comprehensive income. Accordingly, the discontinued operations were retrospectively reflected for all the years presented in our consolidated statements of comprehensive income included in this annual report.

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For the year ended December 31,

2007 2008
(in US\$ thousands, except for shi 2009 2010 2011

	(in US\$ thousands, except for share, ADS, percentages, and operating data)							
Statement of Comprehensive								
Income: Sales	\$1,523,502	\$1,322,092	\$1,037,665	\$1,532,449	\$1,319,466			
Cost of sales ⁽¹⁾	1,390,187	1,393,788	1,158,148	1,229,266	1,217,525			
Gross profit (loss)	133,315	(71,696)	(120,483)	303,183	101,941			
Operating expenses (income):	100,010	(71,000)	(120,400)	000,100	101,541			
Research and development	96,686	105,577	176,420	191,046	191,473			
General and administrative	68,775	62,466	215,845	41,387	57,435			
Selling and marketing	18,489	20,434	26,209	29,087	32,558			
Impairment loss of long-lived								
assets		106,741	126,635	5,138	17,691			
Loss (gain) from sale of plant and								
equipment and other fixed assets	(28,651)	(2,890)	3,891	97	509			
Litigation settlement			269,637					
Other operating income				(16,493)	(7,009)			
Total operating expenses, net	155,299	292,328	818,637	250,262	292,657			
Income (loss) from operations	(21,984)	(364,024)	(939,120)	52,921	(190,716)			
Other income (expenses):								
Interest income	11,506	11,289	2,547	4,086	4,724			
Interest expense	(37,936)	(50,733)	(24,587)	(22,563)	(20,583)			
Change in the fair value of commitment								
to issue shares and warrants			(30,101)	(29,815)				
Foreign currency exchange								
gain	8,039	11,261	7,291	5,101	17,589			
Other, net	2,099	6,371	(4,549)	6,534	6,709			
Total other income (expense), net	(16,292)	(21,812)	(49,399)	(36,657)	8,439			
Income (loss) from continuing								
operations before income tax and equity investment	(38,276)	(385,836)	(988,519)	16,264	(182,277)			
Income tax benefit (expense)	29,720	(26,433)	46,624	4,818	(82,503)			
Gain (loss) from equity investment	(4,013)	(20,433)	(1,782)	285	4,479			
Income (loss) from continuing	(4,013)	(444)	(1,702)	203	4,475			
operations	(12,569)	(412,713)	(943,677)	21,367	(260,301)			
Income (loss) from discontinued	(12,000)	(112,710)	(010,011)	21,007	(200,001)			
operations net of tax effect	(9,755)	(19,667)	(18,800)	(7,356)	14,741			
Net income (loss)	(22,324)	(432,380)	(962,477)	14,011	(245,560)			
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	For the year ended 2007 (in US\$ thousands,	2008	2009 re, ADS, percentages	2010 s, and operating data	2011)_
Accretion of					
interest to					
noncontrolling interest	2,856	(7,851)	(1,060)	(1,050)	(1,319)
Loss attributed to				140	60
noncontrolling interest Net income				140	63
(loss) attributable					
to Semiconductor					
Manufacturing					
International					
Corporation	(19,468)	(440,231)	(963,537)	13,100	(246,816)
Deemed dividends on	(10,100)	(110,201)	(000,007)	10,100	(= 10,010)
convertible preferred shares					(64,970)
Net income (loss)					(0.1,01.0)
attributable to					
holders of ordinary					
shares	(19,468)	(440,231)	(963,537)	13,100	(311,786)
Net Income (loss)	(22,324)	(432,380)	(962,477)	14,011	(245,560)
Other					
comprehensive					
income (loss):					
Foreign currency					
translation	(0.1)	(107)	F.0	(700)	4 000
adjustment	(94)	(437)	53	(706)	4,938
Comprehensive	(00.440)	(400.047)	(000,404)	40.005	(040,000)
income (loss)	(22,418)	(432,817)	(962,424)	13,305	(240,622)
Comprehensive income (loss)					
attribute to					
noncontrolling					
interest	2,856	(7,851)	(1,060)	(910)	(1,256)
Comprehensive	2,000	(7,001)	(1,000)	(010)	(1,200)
income (loss)					
attribute to					
Semiconductor					
Manufacturing					
International					
Corporation	(19,562)	(440,668)	(963,484)	12,395	(241,878)
Earnings (loss) per ordinary		_			
share, basic	\$ (0.00)	\$ (0.02)	\$ (0.04)	\$ 0.00	\$ (0.01)
Earnings					
(loss) per					
ordinary share,	Φ (0.00)	Φ (0.00)	Φ (0.04)	Φ 0.00	h (0.04)
diluted	\$ (0.00)	\$ (0.02)	\$ (0.04)	\$ 0.00	\$ (0.01)
Weighted average					
shares used in					
computing basic earnings (loss) per					
ordinary share ⁽²⁾⁽³⁾	18,501,940,489,	682 544 866	22,359,237,084	24,258,437,559	27,435,853,922
Weighted average	10,501,540,400,	002,074,000	22,000,201,004	24,200,407,009	21,700,000,922
shares used in					